

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

### **Product image**



















High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

#### General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.00 mm, Number of poles: 3, 90°, Solder pin length (I): 3.2 mm, Gold- plated, black, Tape
Order No.	<u>1067740000</u>
Туре	SL-SMT 5.00HC/03/90G 3.2AU BK RL
GTIN (EAN)	4032248821730
Qty.	350 pc(s).
Product data	IEC: / 27.5 A UL: / 18.5 A
Packaging	Tape

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# **Technical data**

#### **Dimensions and weights**

Depth	12 mm	Depth (inches)	0.472 inch
Height	11.7 mm	Height (inches)	0.461 inch
Height of lowest version	8.5 mm	Net weight	2.626 g
Width	18.2 mm	Width (inches)	0.717 inch

#### **System specifications**

Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	90°
Number of poles	3	Solder pin length (I)	3.2 mm
Solder pin length tolerance	+0.1 / -0.2 mm	Solder pin dimensions	d = 1.2 mm, Octagonal
Solder pin dimensions = d tolerance	0 / -0,03 mm	L1 in mm	10 mm
L1 in inches	0.394 inch	Number of rows	1
Pin series quantity	1	Volume resistance	≤5 mΩ
Plugging force/pole, max.	7 N	Pulling force/pole, max.	5.5 N

#### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
Contact material	CuMg	Contact surface	Gold-plated
Layer structure of solder connection	13 µm Ni / 24 µm Sn matt	Layer structure of plug contact	13 µm Ni / 24 µm Sn / 1.72.3 µm Au
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
Temperature range, installation, min.	-30 °C	Temperature range, installation, max.	100 °C

#### Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	19 A	(Tu=40°C)	24 A
Rated current, max. number of poles			
(Tu=40°C)	16.5 A		

#### Rated data acc. to CSA

Institute (CSA)	<b>⊕</b> .	Certificate No. (CSA)	000000 4470045
			200039-1176845
Rated current (Use group B / CSA)	15 A	Rated current (Use group D / CSA)	15 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		



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# **Technical data**

#### Rated data acc. to UL 1059

Rated data acc. to UL 10	59		
Institute (UR)		Certificate No. (UR)	
mouture (OH)	<i>71</i>	certificate No. (Off)	
B	4050)		E60693
Rated current (Use group B / UL	1059)	Reference to approval values	Specifications are maximum values, details -
	18.5 A		see approval certificate.
Packing			
	_	VDE	10
Packaging	Tape	VPE length	40 mm
VPE width	330 mm	VPE height	330 mm
Tape depth (T2)	12.8 mm	Tape width (W)	32 mm
Tape pocket depth (K0)	12.3 mm	Tape pocket height (A0)	12.3 mm
Tape pocket width (B0)	18.74 mm	Tape pocket separation (P1)	16 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	14.2 mm
Tape reel diameter ∅ (A)	330 mm	Surface resistance	$Rs = 10^9 - 10^{12} \Omega$
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note				
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties			

Notes • Gold-plated contact surfaces on request

- Rated current related to rated cross-section & min. No. of poles.
- Diameter of solder eyelet D = 1.4+0.1mm
- Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.

in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

#### **Approvals**

Approvals

РОЦС



nuna	Colliottii	
UL File Number Search	E60693	



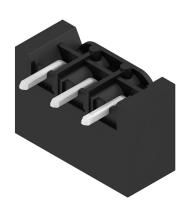
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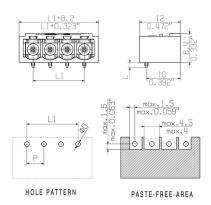
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# **Drawings**

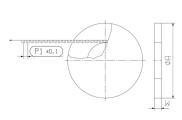
### **Product image**



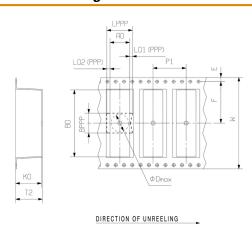
### **Dimensional drawing**



#### **Dimensional drawing**



#### **Dimensional drawing**

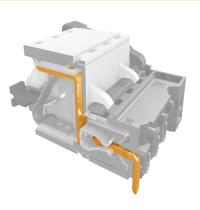


#### **Example of use**



Compliant with existing standards

#### **Product benefits**



Safe power transmission Proven properties



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# **Drawings**

#### **Product benefits**





### Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

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#### Single Wave:



#### **Double Wave:**



#### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



### Recommended reflow soldering profile

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#### **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.